

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
Sheng-Yuan Chu		08/14/2006
Ching-Wen Lai		08/14/2006
RECEIVING PARTY DATA		
Name:	NOVATEK Microelectronics Corp.	
Street Address:	2F, No. 13, Innovation Rd. I, Hsinchu Science Park	
City:	Hsin-Chu	
State/Country:	TAIWAN	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11465125	
CORRESPONDENCE DATA		
Fax Number:	(703)997-4517	
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
Phone:	3027291562	
Email:	Patent.admin.uspto.cr@naipo.com	
Correspondent Name:	WINSTON HSU	
Address Line 1:	P.O.BOX 506	
Address Line 4:	Merrifield, VIRGINIA 22116	
ATTORNEY DOCKET NUMBER:	NVAP0024USA	
NAME OF SUBMITTER:	WINSTON HSU	
Total Attachments: 2 source=NVAP0024USA0_A1_1_NP005#page1.tif source=NVAP0024USA0_A1_1_NP005#page2.tif		

CH \$40.00 11465125

500139687

PATENT
REEL: 018124 FRAME: 0627

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Sheng-Yuan Chu Nationality: R.O.C.

Address: No.21, Lane 44, Datong N. Rd., Sanchong City, Taipei County, Taiwan, R.O.C.

Name: Ching-Wen Lai Nationality: R.O.C.

Address: 2F., No.3-8, Huaide St., Beitou District, Taipei City, Taiwan, R.O.C.

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: NOVATEK Microelectronics Corp.

Address: 2F, No. 13, Innovation Rd. I, Hsinchu Science Park, Hsin-Chu 300, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"SYSTEMS AND METHODS CAPABLE OF CONTROLLING MULTIPLE DATA ACCESS"

Which is found in :

- (a) + U.S. patent application executed on even date
(b) _____ U.S. patent application executed on _____
(c) _____ U.S. application serial no. _____
(d) _____ patent no. _____ issued _____

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this AUG 14 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Sheng-Yuan Chu

Ching-Wen Lai

Signature of INVENTOR

Sheng-Yuan Chu

Ching-Wen Lai

PATENT

RECORDED: 08/17/2006

REEL: 018124 FRAME: 0629